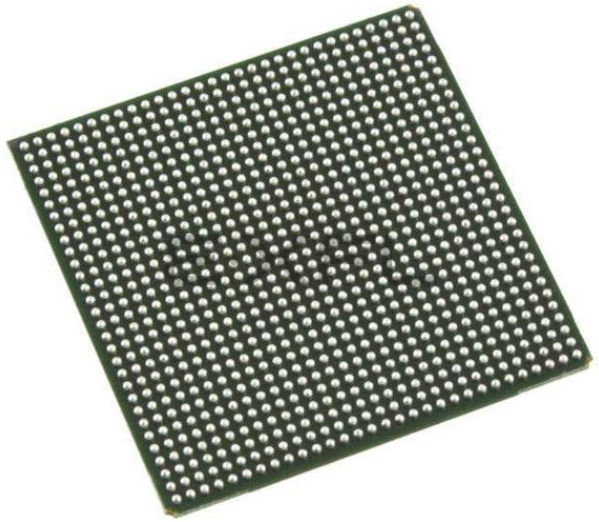
Lattice Semiconductor Corporation - LFSCM3GA25EP1-6FN900C Datasheet



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Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	6250
Number of Logic Elements/Cells	25000
Total RAM Bits	1966080
Number of I/O	378
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	900-BBGA
Supplier Device Package	900-FPBGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfscm3ga25ep1-6fn900c

LatticeSC/M Family Data Sheet Architecture

December 2008 **Data Sheet DS1004**

Architecture Overview

The LatticeSC architecture contains an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM Embedded Block RAM (EBR). The upper left and upper right corners of the devices contain SERDES blocks and their associated PCS blocks, as show in Figure 2-1.

Top left and top right corner of the device contain blocks of SERDES. Each block of SERDES contains four channels (quad). Each channel contains a single serializer and de-serializer, synchronization and word alignment logic. The SERDES quad connects with the Physical Coding Sub-layer (PCS) blocks that contain logic to simultaneously perform alignment, coding, de-coding and other functions. The SERDES quad block has separate supply, ground and reference voltage pins.

The PICs contain logic to facilitate the conditioning of signals to and from the I/O before they leave or enter the FPGA fabric. The block provides DDR and shift register capabilities that act as a gearbox between high speed I/O and the FPGA fabric. The blocks also contain programmable Adaptive Input Logic that adjusts the delay applied to signals as they enter the device to optimize setup and hold times and ensure robust performance.

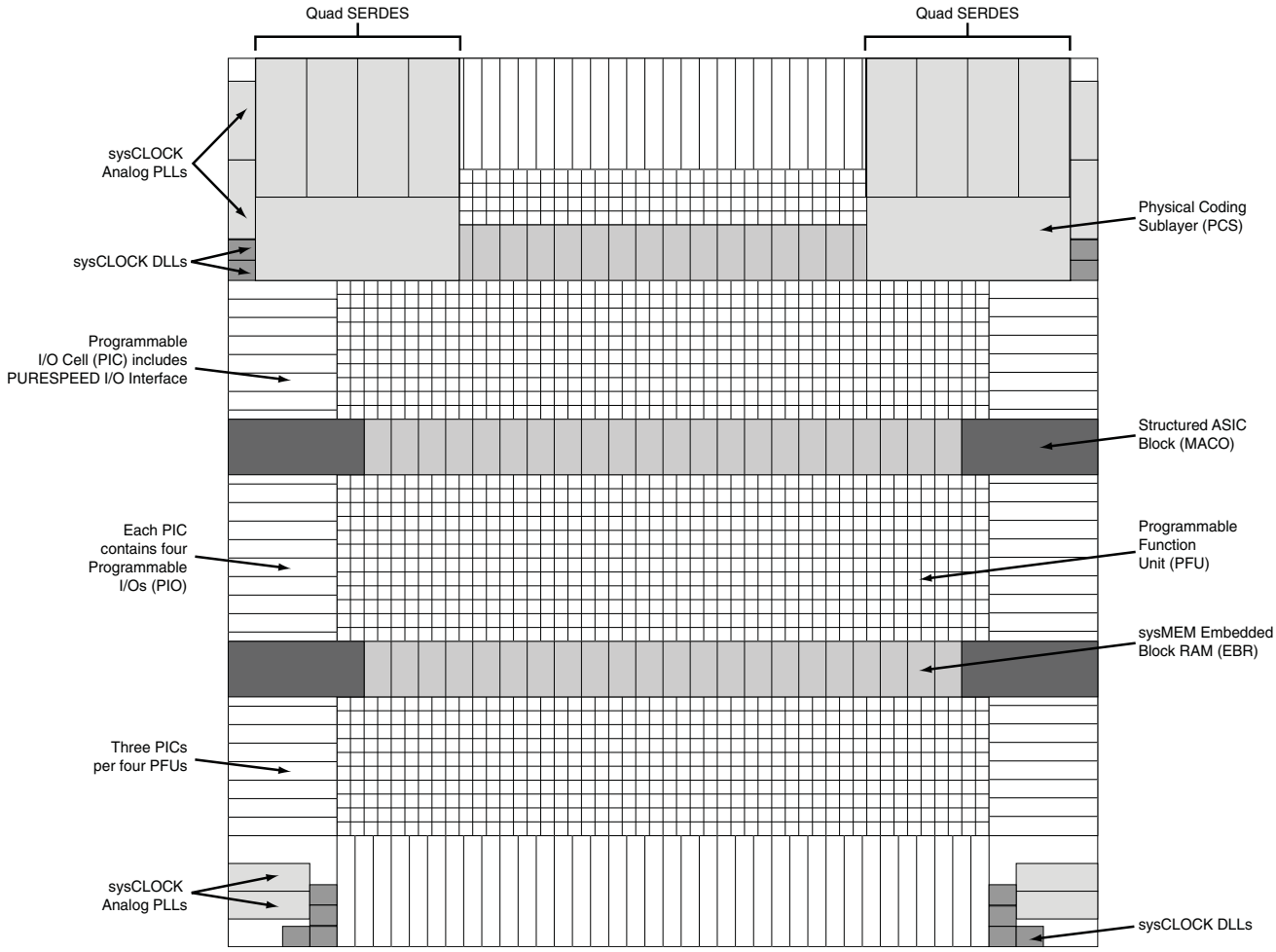
sysMEM EBRs are large dedicated fast memory blocks. They can be configured as RAM, ROM or FIFO. These blocks have dedicated logic to simplify the implementation of FIFOs.

The PFU, PIC and EBR blocks are arranged in a two-dimensional grid with rows and columns as shown in Figure 2-1. These blocks are connected with many vertical and horizontal routing channel resources. The place and route software tool automatically allocates these routing resources.

The corners contain the sysCLOCK Analog Phase Locked Loop (PLL) and Delay Locked Loop (DLL) Blocks. The PLLs have multiply, divide and phase shifting capability; they are used to manage the phase relationship of the clocks. The LatticeSC architecture provides eight analog PLLs per device and 12 DLLs. The DLLs provide a simple delay capability and can also be used to calibrate other delays within the device.

Every device in the family has a JTAG Port with internal Logic Analyzer (ispTRACY) capability. The sysCONFIG™ port which allows for serial or parallel device configuration. The system bus simplifies the connections of the external microprocessor to the device for tasks such as SERDES and PCS configuration or interface to the general FPGA logic. The LatticeSC devices use 1.2V as their core voltage operation with 1.0V operation also possible.

Figure 2-1. Simplified Block Diagram (Top Level)



Modes of Operation

Each Slice is capable of four modes of operation: Logic, Ripple, RAM and ROM. Table 2-2 lists the modes and the capability of the Slice blocks.

Table 2-2. Slice Modes

	Logic	Ripple	RAM	ROM
PFU Slice	LUT 4x2 or LUT 5x1	2-bit Arithmetic Unit	SPR 16x2 DPR 16x2	ROM 16x2

Logic Mode

In this mode, the LUTs in each Slice are configured as combinatorial lookup tables. A LUT4 can have 16 possible input combinations. Any logic function with four inputs can be generated by programming this lookup table. Since there are two LUT4s per Slice, a LUT5 can be constructed within one Slice. Larger lookup tables such as LUT6, LUT7 and LUT8 can be constructed by concatenating other Slices in the PFU.

Ripple Mode

Ripple mode allows the efficient implementation of small arithmetic functions. In ripple mode, the following functions can be implemented by each Slice:

- Addition 2-bit
- Subtraction 2-bit
- Up counter 2-bit
- Down counter 2-bit
- Comparator functions of A and B inputs
  - A greater-than-or-equal-to B
  - A not-equal-to B
  - A less-than-or-equal-to B

Ripple Mode includes an optional configuration that performs arithmetic using fast carry chain methods. In this configuration (also referred to as CCU2 mode) two additional signals, Carry Generate and Carry Propagate, are generated on a per slice basis to allow fast arithmetic functions to be constructed by concatenating Slices.

RAM Mode

In this mode, distributed RAM can be constructed using each LUT block as a 16x1-bit memory. Through the combination of LUTs and Slices, a variety of different memories can be constructed.

The Lattice design tools support the creation of a variety of different size memories. Where appropriate, the software will construct these using distributed memory primitives that represent the capabilities of the Slice. Table 2-3 shows the number of Slices required to implement different distributed RAM primitives. Dual port memories involve the pairing of two Slices, one Slice functions as the read-write port. The other companion Slice supports the read-only port. For more information on RAM mode, please see details of additional technical documentation at the end of this data sheet.

Table 2-3. Number of Slices Required For Implementing Distributed RAM

	SPR16x2	DPR16x2
Number of Slices	1	2

Note: SPR = Single Port RAM, DPR = Dual Port RAM

ROM Mode

The ROM mode uses the same principal as the RAM modes, but without the Write port. Pre-loading is accomplished through the programming interface during configuration.

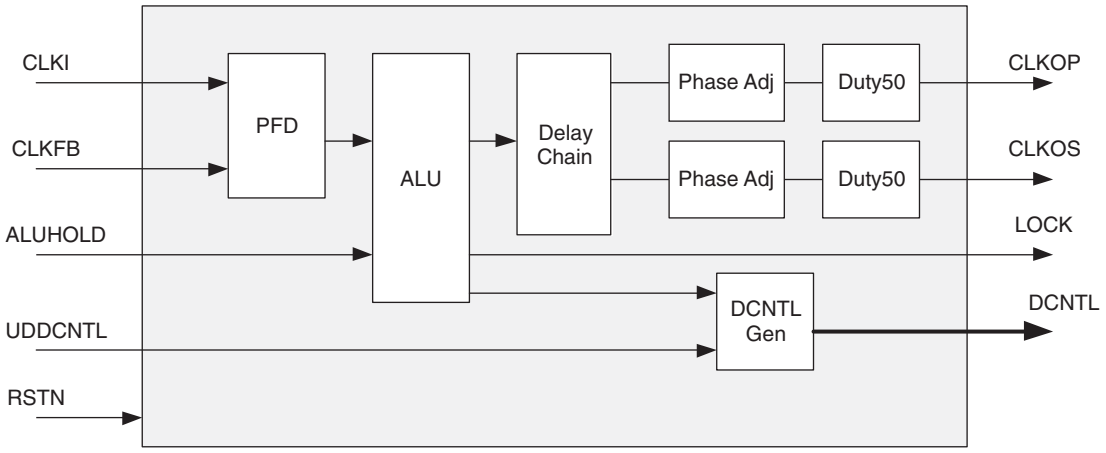
There is a Digital Control (DCNTL) bus available from the DLL block. This Digital Control bus is available to the delay lines in the PIC blocks in the adjacent banks. The UDDCNTL signal allows the user to latch the current value on the digital control bus.

Figure 2-12 shows the DLL block diagram of the DLL inputs and outputs. The output of the phase frequency detector controls an arithmetic logic unit (ALU) to add or subtract one delay tap. The digital output of this ALU is used to control the delay value of the delay chain and this digital code is transmitted via the DCNTL bus.

The sysCLOCK DLL can be configured at power-up, then, if desired, reconfigured dynamically through the Serial Memory Interface bus which interfaces with the on-chip Microprocessor Interface (MPI) bus. In addition, users can drive the SMI interface from routing if desired.

The user can configure the DLL for many common functions such as clock injection match and single delay cell. Lattice provides primitives in its design for time reference delay (DDR memory) and clock injection delay removal.

Figure 2-12. DLL Diagram



PLL/DLL Cascading

The LatticeSC devices have been designed to allow certain combinations of PLL and DLL cascading. The allowable combinations are as follows:

- PLL to PLL
- PLL to DLL
- DLL to DLL
- DLL to PLL

DLLs are used to shift the clock in relation to the data for source synchronous inputs. PLLs are used for frequency synthesis and clock generation for source synchronous interfaces. Cascading PLL and DLL blocks allows applications to utilize the unique benefits of both DLL and PLLs.

When cascading the DLL to the PLL, the DLL can be used to drive the PLL to create fine phase shifts of an input clock signal. Figure 2-13 shows a shift of all outputs for CLKOP and CLKOS out in time.

Table 2-9. Supported Input Standards

Input Standard	V_{REF} (Nom.)	V_{CCIO}[1] (Nom.)	On-chip Termination
Single Ended Interfaces			
LVTTL33[3]	—	3.3	None
LVCMOS 33, 25, 18, 15, 12[3]	—	3.3/2.5/1.8/1.5/1.2	None
PCI33, PCIX33, AGP1X33[3]	—	3.3	None
PCIX15	0.75	1.5[2]	None / V_{CCIO} / 2: 50, 60/ V_{TT}: 60, 75, 120, 210
AGP2X33	1.32	—	None
HSTL18_I, II	0.9	1.8[2]	None / V_{CCIO} / 2: 50, 60/ V_{TT}: 60, 75, 120, 210
HSTL18_III, IV	1.08	1.8[2]	None / V_{CCIO}: 50
HSTL15_I, II	0.75	1.5[2]	None / V_{CCIO} / 2: 50, 60/ V_{TT}: 60, 75, 120, 210
HSTL15_III, IV	0.9	1.5[2]	None / V_{CCIO}: 50
SSTL33_I, II	1.5	3.3	None
SSTL25_I, II	1.25	2.5[2]	None / V_{CCIO} / 2: 50, 60/ V_{TT}: 60, 75, 120, 210
SSTL18_I, II	0.9	1.8[2]	None / V_{CCIO} / 2: 50, 60/ V_{TT}: 60, 75, 120, 210
GTL+, GTL	1.0 / 0.8	1.5 / 1.2[2]	None / V_{CCIO}: 50
Differential Interfaces			
SSTL18D_I, II	—	1.8[2]	None / Diff: 120, 150, 220, 420/ Diff to V_{CMT}: 120, 150, 220, 420 / V_{CCIO} / 2: 50, 60/ V_{TT}: 60, 75, 120, 210
SSTL25D_I, II	—	2.5[2]	None / Diff: 120, 150, 220, 420/ Diff to V_{CMT}: 120, 150, 220, 420 / V_{CCIO} / 2: 50, 60/ V_{TT}: 60, 75, 120, 210
SSTL33D_I, II	—	3.3	None
HSTL15D_I, II	—	1.5[2]	None / Diff: 120, 150, 220, 420/ Diff to V_{CMT}: 120, 150, 220, 420 / V_{CCIO} / 2: 50, 60/ V_{TT}: 60, 75, 120, 210
HSTL18D_I, II	—	1.8[2]	None / Diff: 120, 150, 220, 420/ Diff to V_{CMT}: 120, 150, 220, 420 / V_{CCIO} / 2: 50, 60/ V_{TT}: 60, 75, 120, 210
LVDS	—	—	None / Diff: 120, 150, 220, 240/ Diff to V_{CMT}: 120, 150, 220, 240
Mini-LVDS	—	—	None / Diff: 120, 150 / Diff to V_{CMT}: 120, 150
BLVDS25	—	—	None
MLVDS25	—	—	None
RSDS	—	—	None / Diff: 120, 150, 220, 240/ Diff to V_{CMT}: 120, 150, 220, 240
LVPECL33	—	≤2.5	None / Diff: 120, 150, 220, 240/ Diff to V_{CMT}: 120, 150, 220, 240

1. When not specified V_{CCIO} can be set anywhere in the valid operating range.
2. V_{CCIO} needed for on-chip termination to $V_{CCIO}/2$ or V_{CCIO} only. V_{CCIO} is not specified for off-chip termination or V_{TT} termination.
3. All ratioed input buffers and dedicated pin input buffers include hysteresis with a typical value of 50mV.

LatticeSC/M External Switching Characteristics[3]

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
General I/O Pin Parameters (using Primary Clock without PLL)[2]								
t_{CO}	Global Clock Input to Output - PIO Output Register	2.83	5.74	2.83	6.11	2.83	6.49	ns
t_{SU}	Global Clock Input Setup - PIO Input Register without fixed input delay	-0.66	—	-0.66	—	-0.66	—	ns
t_{H}	Global Clock Input Hold - PIO Input Register without fixed input delay	1.73	—	1.95	—	2.16	—	ns
t_{SU_IDLY}	Global Clock Input Setup - PIO Input Register with input delay	0.86	—	1.03	—	1.20	—	ns
t_{H_IDLY}	Global Clock Input Hold - PIO Input Register with input delay	-0.17	—	-0.17	—	-0.17	—	ns
f_{MAX_PFU}	Global Clock frequency of PFU register	—	700	—	700	—	700	MHz
f_{MAX_IO}	Global Clock frequency of I/O register	—	1000	—	1000	—	1000	MHz
t_{GC_SKEW}	Global Clock skew	—	89	—	103	—	116	ps
General I/O Pin Parameters (using Primary Clock with PLL)[1, 2]								
t_{CO}	Global Clock Input to Output - PIO Output Register	2.25	4.81	2.25	5.08	2.25	5.37	ns
t_{SU}	Global Clock Input Setup - PIO Input Register without fixed input delay	-0.07	—	-0.07	—	-0.07	—	ns
t_{H}	Global Clock Input Hold - PIO Input Register without fixed input delay	0.80	—	0.93	—	1.04	—	ns
General I/O Pin Parameters (using Edge Clock without PLL)[2]								
t_{CO}	Edge Clock Input to Output - PIO Output Register	2.38	4.77	2.38	5.04	2.38	5.33	ns
t_{SU}	Edge Clock Input Setup - PIO Input Register without fixed input delay	-0.08	—	-0.08	—	-0.08	—	ns
t_{H}	Edge Clock Input Hold - PIO Input Register	0.49	—	0.58	—	0.66	—	ns
t_{SU_IDLY}	Edge Clock Input Setup - PIO Input Register with input delay	0.81	—	0.97	—	1.12	—	ns
t_{H_IDLY}	Edge Clock Input Hold - PIO Input Register with input delay	-0.34	—	-0.34	—	-0.34	—	ns
t_{EC_SKEW}	Edge Clock skew	—	28	—	32	—	36	ps
General I/O Pin Parameters (using Latch FF without PLL)[2]								
t_{SU}	Latch FF, Input Setup - PIO Input Register without fixed input delay	-0.14	—	-0.14	—	-0.14	—	ns
t_{H}	Latch FF, Input Hold - PIO Input Register without fixed input delay	0.58	—	0.68	—	0.77	—	ns
t_{SU_IDLY}	Latch FF, Input Setup - PIO Input Register with input delay	0.70	—	0.68	—	0.77	—	ns
t_{H_IDLY}	Latch FF, Input Hold - PIO Input Register with input delay	-0.30	—	-0.30	—	-0.30	—	ns

1. No PLL delay tuning (clock injection removal mode, system clock feedback).
2. Using LVCMOS25 12mA I/O. Timing adders for other supported I/O technologies are specified in the LatticeSC Family Timing Adders table.
3. Complete Timing Parameters for a user design are incorporated when running ispLEVER. This is a sampling of the key timing parameters. Timing specs are for non-AIL applications.

LatticeSC/M sysCONFIG Port Timing (Continued)

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Asynchronous Peripheral Configuration Mode				
t_{WRAP}	WRN, CS0N and CS1 Pulse Width	5	-	ns
t_{SAP}	D[7:0] Setup Time	1.5	-	ns
t_{RDYAP}	RDY Delay	—	8	ns
t_{BAP}	RDY Low	1	8	CCLK periods
t_{WR2AP}	Earliest WRN After RDY Goes High	0	—	ns
t_{DENAP}	RDN to D[7:0] Enable/Disable	—	7.5	ns
t_{DAP}	CCLK to DOUT	—	7.5	ns
sysCONFIG Slave Serial Configuration Mode				
t_{SSS}	DIN Setup Time	5.2	—	ns
t_{HSS}	DIN Hold Time	0	—	ns
t_{CHSS}	CCLK High Time	3.75	—	ns
t_{CLSS}	CCLK Low Time	3.75	—	ns
f_{CSS}	CCLK Frequency	—	150	MHz
t_{DSS}	CCLK to DOUT	—	7.5	ns
sysCONFIG Slave Parallel Configuration Mode				
t_{S1SP}	CS0N, CS1, WRN Setup Time	5.2	—	ns
t_{H1SP}	CS0N, CS1, WRN Hold Time	0	—	ns
t_{S2SP}	D[7:0] Setup Time	5.2	—	ns
t_{H2SP}	D[7:0] Hold Time	0	—	ns
t_{CHSP}	CCLK High Time	3.75	—	ns
t_{CL}	CCLK Low Time	3.75	—	ns
f_{CSP}	CCLK Frequency	—	150	MHz

sysCONFIG MPI Port

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
$t_{MPICTRL\_SET}$	MPI Control (MPCSTRBN, MPCWRN, MPCCLK, etc.) to MPCCLK Setup Time	4.9	—	5.2	—	5.5	—	ns
t_{MPIADR_SET}	MPI Address to MPCCLK Setup Time	3.9	—	4.2	—	4.5	—	ns
t_{MPIDAT_SET}	MPI Write Data to MPCCLK Setup Time	4.9	—	5.2	—	5.5	—	ns
$t_{MPIDPAR\_SET}$	MPI Write Parity Data to MPCCLK Setup Time	3.9	—	4.2	—	4.5	—	ns
t_{MPI_HLD}	All Hold Times	0	—	0	—	0	—	ns
$t_{MPICTRL\_DEL}$	MPCCLK to MPI Control (MPCTA, MPC-TEA, MPCRETRY)	—	5.6	—	6.7	—	8.7	ns
t_{MPIDAT_DEL}	MPCCLK to MPI Data	—	5.6	—	6.7	—	8.7	ns
$t_{MPIDPAR\_DEL}$	MPCCLK to MPI Parity Data	—	4.9	—	5.7	—	7.7	ns
$f_{MPI\_CLK\_FRQ}$	MPCCLK Frequency	—	100	—	83	—	66	MHz

Switching Test Conditions

Figure 3-15 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 3-4.

Figure 3-15. Output Test Load, LVTTL and LVCMOS Standards

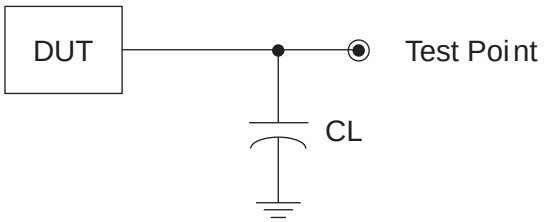


Table 3-4. Test Fixture Required Components, Non-Terminated Interfaces

Test Condition	C_L	Timing Ref.	V_T
LVTTL and other LVCMOS settings (L -> H, H -> L)	30pF	LVCMOS 3.3 = 1.5V	—
		LVCMOS 2.5 = $V_{CCIO}/2$	—
		LVCMOS 1.8 = $V_{CCIO}/2$	—
		LVCMOS 1.5 = $V_{CCIO}/2$	—
		LVCMOS 1.2 = $V_{CCIO}/2$	—
LVCMOS 2.5 I/O (Z -> H)	30pF	$V_{CCIO}/2$	V_{OL}
LVCMOS 2.5 I/O (Z -> L)		$V_{CCIO}/2$	V_{OH}
LVCMOS 2.5 I/O (H -> Z)		V_{OH} - 0.15	V_{OL}
LVCMOS 2.5 I/O (L -> Z)		V_{OL} + 0.15	V_{OH}

Note: Output test conditions for all other interfaces are determined by the respective standards.

LFSC/M15 Logic Signal Connections: 256 fpBGA[1,2] (Cont.)

Ball Number	LFSC/M15		
	Ball Function	VCCIO Bank	Dual Function
J9	VCC	-	
K8	VCC	-	
F6	VCC12	-	
F11	VCC12	-	
L11	VCC12	-	
L6	VCC12	-	
K7	VCC12	-	
K10	VCC12	-	
F10	VCCAUX	-	
F7	VCCAUX	-	
T1	GND	-	
G11	VCCAUX	-	
K11	VCCAUX	-	
L10	VCCAUX	-	
L9	VCCAUX	-	
L7	VCCAUX	-	
L8	VCCAUX	-	
T16	GND	-	
G6	VCCAUX	-	
K6	VCCAUX	-	
B13	VCCIO1	-	
D11	VCCIO1	-	
D14	VCCIO1	-	
F12	VCCIO2	-	
G15	VCCIO2	-	
K14	VCCIO3	-	
N15	VCCIO3	-	
M11	VCCIO4	-	
P13	VCCIO4	-	
R10	VCCIO4	-	
N6	VCCIO5	-	
P7	VCCIO5	-	
R4	VCCIO5	-	
K2	VCCIO6	-	
N3	VCCIO6	-	
F4	VCCIO7	-	
G3	VCCIO7	-	
D4	VCC12	-	
D7	VCC12	-	
D5	VCC12	-	
D6	VCC12	-	

1. Differential pair grouping within a PIC is A (True) and B (Complement) and C (True) and D (Complement).
2. The LatticeSC/M15 in a 256-pin package does not support an MPI interface.

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AK14	PB25A	5		PB35A	5	
AK15	PB25B	5		PB35B	5	
AK16	PB27A	4		PB37A	4	
AK17	PB27B	4		PB37B	4	
AJ16	PB28A	4		PB38A	4	
AJ17	PB28B	4		PB38B	4	
AE16	PB28C	4		PB38C	4	
AH16	PB29A	4		PB39A	4	
AG16	PB29B	4		PB39B	4	
AK18	PB31A	4		PB41A	4	
AK19	PB31B	4		PB41B	4	
AH17	PB32A	4		PB42A	4	
AH18	PB32B	4		PB42B	4	
AG17	PB32D	4		PB42D	4	
AJ18	PB33A	4		PB43A	4	
AJ19	PB33B	4		PB43B	4	
AK20	PB35A	4	PCLKT4_2	PB46A	4	PCLKT4_2
AK21	PB35B	4	PCLKC4_2	PB46B	4	PCLKC4_2
AF18	PB36A	4	PCLKT4_1	PB47A	4	PCLKT4_1
AG18	PB36B	4	PCLKC4_1	PB47B	4	PCLKC4_1
AJ20	PB37A	4	PCLKT4_0	PB49A	4	PCLKT4_0
AJ21	PB37B	4	PCLKC4_0	PB49B	4	PCLKC4_0
AG19	PB37C	4	VREF2_4	PB49C	4	VREF2_4
AK22	PB39A	4	PCLKT4_5	PB51A	4	PCLKT4_5
AK23	PB39B	4	PCLKC4_5	PB51B	4	PCLKC4_5
AH19	PB39C	4		PB51C	4	
AK24	PB40A	4	PCLKT4_3	PB52A	4	PCLKT4_3
AK25	PB40B	4	PCLKC4_3	PB52B	4	PCLKC4_3
AE19	PB40C	4	PCLKT4_4	PB52C	4	PCLKT4_4
AE20	PB40D	4	PCLKC4_4	PB52D	4	PCLKC4_4
AE21	PB41A	4		PB53A	4	
AF21	PB41B	4		PB53B	4	
AG21	PB43A	4		PB55A	4	
AG22	PB43B	4		PB55B	4	
AH22	PB44A	4		PB56A	4	
AH23	PB44B	4		PB56B	4	
AH21	PB44C	4		PB56C	4	
AK28	PB45A	4		PB60A	4	
AK29	PB45B	4		PB60B	4	
AE22	PB45C	4		PB60C	4	
AJ28	PB47A	4		PB67A	4	
AH28	PB47B	4		PB67B	4	
AE24	PB47C	4	VREF1_4	PB67C	4	VREF1_4
AE25	PB47D	4		PB67D	4	
AJ29	PB48A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D	PB68A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AJ27	GND	-		GND	-	
AF23	GND	-		GND	-	
AF22	GND	-		GND	-	
AE27	GND	-		GND	-	
AA27	GND	-		GND	-	
AB29	GND	-		GND	-	
Y26	GND	-		GND	-	
AC30	GND	-		GND	-	
Y29	GND	-		GND	-	
F30	GND	-		GND	-	
E27	GND	-		GND	-	
F27	GND	-		GND	-	
P25	GND	-		GND	-	
H29	GND	-		GND	-	
K29	GND	-		GND	-	
R24	GND	-		GND	-	
M28	GND	-		GND	-	
J27	GND	-		GND	-	
N26	GND	-		GND	-	
E20	GND	-		GND	-	
E21	GND	-		GND	-	
F21	GND	-		GND	-	
F23	GND	-		GND	-	
G23	GND	-		GND	-	
D21	GND	-		GND	-	
D20	GND	-		GND	-	
E18	GND	-		GND	-	
C20	GND	-		GND	-	
C11	GND	-		GND	-	
A12	GND	-		GND	-	
E11	GND	-		GND	-	
F8	GND	-		GND	-	
G8	GND	-		GND	-	
D11	GND	-		GND	-	
D10	GND	-		GND	-	
H7	GND	-		GND	-	
F10	GND	-		GND	-	
E10	GND	-		GND	-	
AC16	NC	-		NC	-	
J22	VCC	-		VCC	-	
J9	VCC	-		VCC	-	
B2	NC	-		NC	-	
C2	RESPN_ULC	-		RESPN_ULC	-	
C29	RESPN_URC	-		RESPN_URC	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
P17	VCC	-		VCC	-	
P19	VCC	-		VCC	-	
R13	VCC	-		VCC	-	
R15	VCC	-		VCC	-	
R18	VCC	-		VCC	-	
R20	VCC	-		VCC	-	
T13	VCC	-		VCC	-	
T14	VCC	-		VCC	-	
T16	VCC	-		VCC	-	
T17	VCC	-		VCC	-	
T19	VCC	-		VCC	-	
T20	VCC	-		VCC	-	
U13	VCC	-		VCC	-	
U14	VCC	-		VCC	-	
U16	VCC	-		VCC	-	
U17	VCC	-		VCC	-	
U19	VCC	-		VCC	-	
U20	VCC	-		VCC	-	
V13	VCC	-		VCC	-	
V15	VCC	-		VCC	-	
V18	VCC	-		VCC	-	
V20	VCC	-		VCC	-	
W14	VCC	-		VCC	-	
W16	VCC	-		VCC	-	
W17	VCC	-		VCC	-	
W19	VCC	-		VCC	-	
Y13	VCC	-		VCC	-	
Y15	VCC	-		VCC	-	
Y16	VCC	-		VCC	-	
Y17	VCC	-		VCC	-	
Y18	VCC	-		VCC	-	
Y20	VCC	-		VCC	-	
C17	VCCIO1	-		VCCIO1	-	
D16	VCCIO1	-		VCCIO1	-	
F15	VCCIO1	-		VCCIO1	-	
F24	VCCIO1	-		VCCIO1	-	
G18	VCCIO1	-		VCCIO1	-	
G9	VCCIO1	-		VCCIO1	-	
J11	VCCIO1	-		VCCIO1	-	
J19	VCCIO1	-		VCCIO1	-	
K14	VCCIO1	-		VCCIO1	-	
K22	VCCIO1	-		VCCIO1	-	
G4	VCCIO2	-		VCCIO2	-	
J7	VCCIO2	-		VCCIO2	-	
K3	VCCIO2	-		VCCIO2	-	
L10	VCCIO2	-		VCCIO2	-	
M6	VCCIO2	-		VCCIO2	-	
N4	VCCIO2	-		VCCIO2	-	
P9	VCCIO2	-		VCCIO2	-	
R7	VCCIO2	-		VCCIO2	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
L33	PL27B	7		PL35B	7	
M30	PL27C	7		PL35C	7	
N30	PL27D	7		PL35D	7	
M31	PL29A	7		PL37A	7	
N31	PL29B	7		PL37B	7	
P24	PL29C	7		PL37C	7	
R24	PL29D	7		PL37D	7	
M33	PL30A	7		PL42A	7	
N33	PL30B	7		PL42B	7	
U25	PL30C	7		PL42C	7	
T25	PL30D	7		PL42D	7	
L34	PL31A	7		PL43A	7	
M34	PL31B	7		PL43B	7	
P29	PL31C	7		PL43C	7	
R29	PL31D	7		PL43D	7	
N34	PL34A	7		PL46A	7	
P34	PL34B	7		PL46B	7	
R27	PL34C	7		PL46C	7	
T27	PL34D	7		PL46D	7	
R32	PL35A	7	PCLKT7_1	PL47A	7	PCLKT7_1
R31	PL35B	7	PCLKC7_1	PL47B	7	PCLKC7_1
U24	PL35C	7	PCLKT7_3	PL47C	7	PCLKT7_3
T24	PL35D	7	PCLKC7_3	PL47D	7	PCLKC7_3
P33	PL36A	7	PCLKT7_0	PL48A	7	PCLKT7_0
R33	PL36B	7	PCLKC7_0	PL48B	7	PCLKC7_0
T26	PL36C	7	PCLKT7_2	PL48C	7	PCLKT7_2
U26	PL36D	7	PCLKC7_2	PL48D	7	PCLKC7_2
T32	PL38A	6	PCLKT6_0	PL50A	6	PCLKT6_0
T31	PL38B	6	PCLKC6_0	PL50B	6	PCLKC6_0
U29	PL38C	6	PCLKT6_1	PL50C	6	PCLKT6_1
V29	PL38D	6	PCLKC6_1	PL50D	6	PCLKC6_1
T30	PL39A	6		PL51A	6	
U30	PL39B	6		PL51B	6	
U27	PL39C	6	PCLKT6_3	PL51C	6	PCLKT6_3
V27	PL39D	6	PCLKC6_3	PL51D	6	PCLKC6_3
R34	PL40A	6		PL52A	6	
T34	PL40B	6		PL52B	6	
U28	PL40C	6	PCLKT6_2	PL52C	6	PCLKT6_2
V28	PL40D	6	PCLKC6_2	PL52D	6	PCLKC6_2
V30	PL43A	6		PL55A	6	
W30	PL43B	6		PL55B	6	
W27	PL43C	6	VREF1_6	PL55C	6	VREF1_6
Y27	PL43D	6		PL55D	6	
T33	PL44A	6		PL56A	6	
U33	PL44B	6		PL56B	6	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AD5	PR94C	3	
AE2	PR94B	3	
AD2	PR94A	3	
AC5	PR92D	3	
AB5	PR92C	3	
AF1	PR92B	3	
AE1	PR92A	3	
AA11	PR91D	3	
Y11	PR91C	3	
AC4	PR91B	3	
AB4	PR91A	3	
AA8	PR90D	3	DIFFR_3
AA9	PR90C	3	
AC3	PR90B	3	
AB3	PR90A	3	
AA7	PR79D	3	
Y7	PR79C	3	
AA2	PR79B	3	
Y2	PR79A	3	
AA6	PR77D	3	
Y6	PR77C	3	
Y4	PR77B	3	
W4	PR77A	3	
W11	PR74D	3	
V11	PR74C	3	
W2	PR74B	3	
V2	PR74A	3	
W9	PR71D	3	
V9	PR71C	3	
V1	PR71B	3	
U1	PR71A	3	
W10	PR70D	3	
V10	PR70C	3	
U2	PR70B	3	
T2	PR70A	3	
Y8	PR69D	3	
W8	PR69C	3	VREF1_3
W5	PR69B	3	
V5	PR69A	3	
V7	PR66D	3	PCLKC3_2
U7	PR66C	3	PCLKT3_2
T1	PR66B	3	
R1	PR66A	3	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
R12	VTT_2	2	
T12	VTT_2	2	
AB11	VTT_3	3	
W12	VTT_3	3	
Y12	VTT_3	3	
AC15	VTT_4	4	
AC16	VTT_4	4	
AD13	VTT_4	4	
AC19	VTT_5	5	
AC20	VTT_5	5	
AD22	VTT_5	5	
AB24	VTT_6	6	
W23	VTT_6	6	
Y23	VTT_6	6	
N24	VTT_7	7	
R23	VTT_7	7	
T23	VTT_7	7	
M12	VDDAX25_R	-	
M23	VDDAX25_L	-	
Y16	GND	-	
Y14	GND	-	
N21	VCC12	-	
P22	VCC12	-	
AA22	VCC12	-	
AB21	VCC12	-	
AB14	VCC12	-	
AA13	VCC12	-	
P13	VCC12	-	
N14	VCC12	-	
G26	NC	-	
G9	NC	-	
J12	NC	-	
H12	NC	-	
H23	NC	-	
J23	NC	-	

1. Differential pair grouping within a PCI is A (True) and B (complement) and C (True) and D (Complement).
2. The LatticeSC/M115 in an 1152-pin package supports a 32-bit MPI interface.

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AG38	NC	-		PL95A	6	
AH38	NC	-		PL95B	6	
AJ39	NC	-		PL100A	6	
AK39	NC	-		PL100B	6	
AL41	NC	-		PL105A	6	
AM41	NC	-		PL105B	6	
AN40	NC	-		PL108A	6	
AM40	NC	-		PL108B	6	
AM39	NC	-		PL111A	6	
AN39	NC	-		PL111B	6	
AR42	NC	-		PL113A	6	
AT42	NC	-		PL113B	6	
AT1	NC	-		PR113B	3	
AR1	NC	-		PR113A	3	
AN4	NC	-		PR111B	3	
AM4	NC	-		PR111A	3	
AM3	NC	-		PR108B	3	
AN3	NC	-		PR108A	3	
AM2	NC	-		PR105B	3	
AL2	NC	-		PR105A	3	
AK4	NC	-		PR100B	3	
AJ4	NC	-		PR100A	3	
AH5	NC	-		PR95B	3	
AG5	NC	-		PR95A	3	
P6	NC	-		PR39B	2	
N6	NC	-		PR39A	2	
L3	NC	-		PR36B	2	
K3	NC	-		PR36A	2	
M5	NC	-		PR35A	2	
L4	NC	-		PR32B	2	
K4	NC	-		PR32A	2	
A2	GND	-		GND	-	
A41	GND	-		GND	-	
AA20	GND	-		GND	-	
AA23	GND	-		GND	-	
AA3	GND	-		GND	-	
AA39	GND	-		GND	-	
AB20	GND	-		GND	-	
AB23	GND	-		GND	-	
AB4	GND	-		GND	-	
AB40	GND	-		GND	-	
AC17	GND	-		GND	-	
AC19	GND	-		GND	-	
AC21	GND	-		GND	-	
AC22	GND	-		GND	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
V21	VCC	-		VCC	-	
V22	VCC	-		VCC	-	
V23	VCC	-		VCC	-	
V25	VCC	-		VCC	-	
V27	VCC	-		VCC	-	
W17	VCC	-		VCC	-	
W19	VCC	-		VCC	-	
W21	VCC	-		VCC	-	
W22	VCC	-		VCC	-	
W24	VCC	-		VCC	-	
W26	VCC	-		VCC	-	
Y16	VCC	-		VCC	-	
Y18	VCC	-		VCC	-	
Y20	VCC	-		VCC	-	
Y23	VCC	-		VCC	-	
Y25	VCC	-		VCC	-	
Y27	VCC	-		VCC	-	
AG22	VCC12	-		VCC12	-	
AG26	VCC12	-		VCC12	-	
T17	VCC12	-		VCC12	-	
T21	VCC12	-		VCC12	-	
T22	VCC12	-		VCC12	-	
T26	VCC12	-		VCC12	-	
U16	VCC12	-		VCC12	-	
U27	VCC12	-		VCC12	-	
AC15	VCCAUX	-		VCCAUX	-	
AC28	VCCAUX	-		VCCAUX	-	
AD15	VCCAUX	-		VCCAUX	-	
AD28	VCCAUX	-		VCCAUX	-	
AE15	VCCAUX	-		VCCAUX	-	
AE28	VCCAUX	-		VCCAUX	-	
AF15	VCCAUX	-		VCCAUX	-	
AF28	VCCAUX	-		VCCAUX	-	
AG15	VCCAUX	-		VCCAUX	-	
AG28	VCCAUX	-		VCCAUX	-	
AH14	VCCAUX	-		VCCAUX	-	
AH16	VCCAUX	-		VCCAUX	-	
AH17	VCCAUX	-		VCCAUX	-	
AH18	VCCAUX	-		VCCAUX	-	
AH19	VCCAUX	-		VCCAUX	-	
AH20	VCCAUX	-		VCCAUX	-	
AH23	VCCAUX	-		VCCAUX	-	
AH24	VCCAUX	-		VCCAUX	-	
AH25	VCCAUX	-		VCCAUX	-	
AH26	VCCAUX	-		VCCAUX	-	

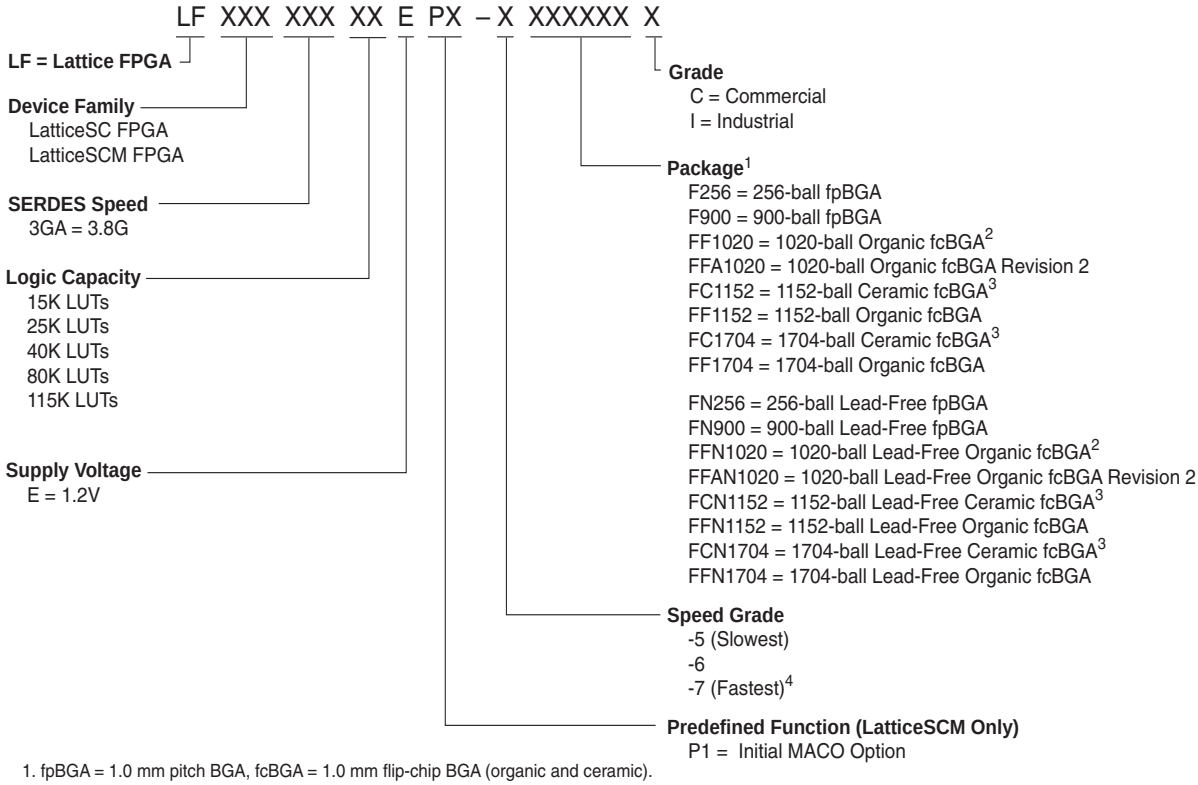
LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AW25	VCCIO5	-		VCCIO5	-	
AW31	VCCIO5	-		VCCIO5	-	
AW37	VCCIO5	-		VCCIO5	-	
AY22	VCCIO5	-		VCCIO5	-	
AY28	VCCIO5	-		VCCIO5	-	
AY34	VCCIO5	-		VCCIO5	-	
AB39	VCCIO6	-		VCCIO6	-	
AC36	VCCIO6	-		VCCIO6	-	
AD32	VCCIO6	-		VCCIO6	-	
AE40	VCCIO6	-		VCCIO6	-	
AF35	VCCIO6	-		VCCIO6	-	
AG31	VCCIO6	-		VCCIO6	-	
AH39	VCCIO6	-		VCCIO6	-	
AJ36	VCCIO6	-		VCCIO6	-	
AK32	VCCIO6	-		VCCIO6	-	
AL40	VCCIO6	-		VCCIO6	-	
AM35	VCCIO6	-		VCCIO6	-	
AP39	VCCIO6	-		VCCIO6	-	
AR36	VCCIO6	-		VCCIO6	-	
AU40	VCCIO6	-		VCCIO6	-	
AA40	VCCIO7	-		VCCIO7	-	
H36	VCCIO7	-		VCCIO7	-	
J40	VCCIO7	-		VCCIO7	-	
L35	VCCIO7	-		VCCIO7	-	
M39	VCCIO7	-		VCCIO7	-	
P36	VCCIO7	-		VCCIO7	-	
R40	VCCIO7	-		VCCIO7	-	
T31	VCCIO7	-		VCCIO7	-	
U35	VCCIO7	-		VCCIO7	-	
V39	VCCIO7	-		VCCIO7	-	
W32	VCCIO7	-		VCCIO7	-	
Y36	VCCIO7	-		VCCIO7	-	
AA14	VTT_2	2		VTT_2	2	
AA15	VTT_2	2		VTT_2	2	
R12	VTT_2	2		VTT_2	2	
V14	VTT_2	2		VTT_2	2	
AB14	VTT_3	3		VTT_3	3	
AB15	VTT_3	3		VTT_3	3	
AE14	VTT_3	3		VTT_3	3	
AJ13	VTT_3	3		VTT_3	3	
AH21	VTT_4	4		VTT_4	4	
AJ18	VTT_4	4		VTT_4	4	
AJ19	VTT_4	4		VTT_4	4	
AJ20	VTT_4	4		VTT_4	4	
AJ21	VTT_4	4		VTT_4	4	

LatticeSC/M Family Data Sheet Ordering Information

January 2010 **Data Sheet DS1004**

Part Number Description



1. fpBGA = 1.0 mm pitch BGA, fcBGA = 1.0 mm flip-chip BGA (organic and ceramic).
2. Converted to organic fcBGA per PCN #02A-10.
3. Converted to organic fcBGA per PCN #01A-10.
4. Not available in the LatticeSC115 and LatticeSCM115 devices.

Ordering Information

Depending on the speed and temperature grade, the device can either be dual marked or single marked. The commercial grade is one speed grade faster than the associated dual marked industrial grade. The slowest commercial speed grade does not have industrial markings. The markings appear as follows:

LFSC3GA25E
6F900C-5I
XXXXXXXX

or

LFSC3GA25E
7F900C
XXXXXXXX

Temperature Grade	Speed Grade	Single or Dual Mark?
Commercial	-7	Either OK
	-6	Dual Only
	-5	Single Only
Industrial	-6	Either OK
	-5	Dual Only

Lead-Free Packaging

Commercial

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA15E-7FN256C	-7	Lead-Free fpBGA	256	COM	15.2
LFSC3GA15E-6FN256C	-6	Lead-Free fpBGA	256	COM	15.2
LFSC3GA15E-5FN256C	-5	Lead-Free fpBGA	256	COM	15.2
LFSC3GA15E-7FN900C	-7	Lead-Free fpBGA	900	COM	15.2
LFSC3GA15E-6FN900C	-6	Lead-Free fpBGA	900	COM	15.2
LFSC3GA15E-5FN900C	-5	Lead-Free fpBGA	900	COM	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA15EP1-7FN256C	-7	Lead-Free fpBGA	256	COM	15.2
LFSCM3GA15EP1-6FN256C	-6	Lead-Free fpBGA	256	COM	15.2
LFSCM3GA15EP1-5FN256C	-5	Lead-Free fpBGA	256	COM	15.2
LFSCM3GA15EP1-7FN900C	-7	Lead-Free fpBGA	900	COM	15.2
LFSCM3GA15EP1-6FN900C	-6	Lead-Free fpBGA	900	COM	15.2
LFSCM3GA15EP1-5FN900C	-5	Lead-Free fpBGA	900	COM	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA25E-7FN900C	-7	Lead-Free fpBGA	900	COM	25.4
LFSC3GA25E-6FN900C	-6	Lead-Free fpBGA	900	COM	25.4
LFSC3GA25E-5FN900C	-5	Lead-Free fpBGA	900	COM	25.4
LFSC3GA25E-7FFN1020C[1]	-7	Lead-Free Organic fcBGA	1020	COM	25.4
LFSC3GA25E-6FFN1020C[1]	-6	Lead-Free Organic fcBGA	1020	COM	25.4
LFSC3GA25E-5FFN1020C[1]	-5	Lead-Free Organic fcBGA	1020	COM	25.4
LFSC3GA25E-7FFAN1020C	-7	Lead-Free Organic fcBGA Revision 2	1020	COM	25.4
LFSC3GA25E-6FFAN1020C	-6	Lead-Free Organic fcBGA Revision 2	1020	COM	25.4
LFSC3GA25E-5FFAN1020C	-5	Lead-Free Organic fcBGA Revision 2	1020	COM	25.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA25EP1-7FN900C	-7	Lead-Free fpBGA	900	COM	25.4
LFSCM3GA25EP1-6FN900C	-6	Lead-Free fpBGA	900	COM	25.4
LFSCM3GA25EP1-5FN900C	-5	Lead-Free fpBGA	900	COM	25.4
LFSCM3GA25EP1-7FFN1020C[1]	-7	Lead-Free Organic fcBGA	1020	COM	25.4
LFSCM3GA25EP1-6FFN1020C[1]	-6	Lead-Free Organic fcBGA	1020	COM	25.4
LFSCM3GA25EP1-5FFN1020C[1]	-5	Lead-Free Organic fcBGA	1020	COM	25.4
LFSCM3GA25EP1-7FFAN1020C	-7	Lead-Free Organic fcBGA Revision 2	1020	COM	25.4
LFSCM3GA25EP1-6FFAN1020C	-6	Lead-Free Organic fcBGA Revision 2	1020	COM	25.4
LFSCM3GA25EP1-5FFAN1020C	-5	Lead-Free Organic fcBGA Revision 2	1020	COM	25.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.